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Dual Bilateral Analog Switch / Digital Multiplexer

The NLX2G66 is a dual single pole, single throw (SPST) analog switch / digital multiplexer. This single supply voltage IC is designed with a sub-micron CMOS technology to provide low propagation delays (t_{pd}) and ON resistance (R_{ON}), while maintaining low power dissipation. This bi-lateral switch can be used with either analog or digital signals that may vary across the full power supply range from V_{CC} to GND.

Features

- Wide V_{CC} Operating Range: 1.65 V to 5.5 V
- OVT up to +5.5 V for Control Pin
- R_{ON}: Typically 5.5 Ω at V_{CC} = 4.5 V and I_S = 32 mA
- Rail-to-Rail Input/Output
- High On–Off Output Voltage Ratio
- High Degree of Linearity
- Ultra-Small Pb-Free, Halide-Free, RoHS-Compliant Packages
- ESD Performance: > 5000 V HBM, > 400 V MM

Typical Applications

• Cell Phones, PDAs, MP3 and other Portable Media Players

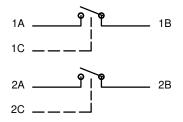


Figure 1. Analog Symbol

PIN ASSIGNMENTS

UDFN8	WLCSP8	Description
1	A1	1A
2	B1	1B
3	C1	2C
4	D1	GND
5	D2	2A
6	C2	2B
7	B2	1C
8	A2	V _{CC}

This document contains information on some products that are still under development. ON Semiconductor reserves the right to change or discontinue these products without notice.



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			MARKIN DIAGRAI	
	UDFN8 MU SUFI CASE 517	FIX	XXM 1 ●	
	UDFN8 MU SUFI CASE 517	FIX	1 • • •	
XX M	= Specif = Date (= Pb–Fr	Code		
*** ⁸	WLCSF FC SUFF CASE 567	-IX	XXXX AYWV	
A Y WV	= Assemt = Year V = Work W		ation	
F	PIN ASSIG	NME	NTS	
1A [<u>1</u>]	[<u>8</u>] V _{CC}	GND	OD1D2O	2A
1B 2]	[7]1C	2C	$\bigcirc C1C2 \bigcirc$	2B

1A	<u>1</u>]	8	V _{CC}	GND	OD1D2O	2A
1B	2]	[7]	1C	2C	OC1C2⊖	2B
2C	3]	[6]	2B	1B	⊖B1B2⊖	1C
GND	4]	[5]	2A	1A	⊖A1 A2⊖	V_{CC}
	UDFI (Top Vi			(WLCSP8 Bottom View)

FUNCTION TABLE

Control Input (C)	Switch
L	OFF
Н	ON

ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 5 of this data sheet.

Table 1. MAXIMUM RATINGS

Symbol	Rating	Value	Unit	
V _{CC}	Positive DC Supply Voltage		-0.5 to +7.0	V
VS	Switch Input / Output Voltage	(Pins 1A, 1B, 2A and 2B)	-0.5 to + V _{CC} + 0.5	V
VI	Digital Control Input Voltage	(Pins 1C and 2C)	-0.5 to +7.0	V
I _{OK}	I/O port diode current		±50	mA
I _{IK}	Control input diode current		-50	mA
I _{I/O}	Continuous DC Current Through Analog Sw	itch	±100	mA
١L	Latch–up Current, (Above V_{CC} and below G	ND at 125°C)	±100	mA
Ts	Storage Temperature		-65 to +150	°C
V_{ESD}	ESD Withstand Voltage: Human Body Machine Mod	Model (HBM) lel (MM)	≥ 5000 > 400	V

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

Table 2. RECOMMENDED OPERATING CONDITIONS

Symbol	Para	Parameter			Unit
V _{CC}	Positive DC Supply Voltage		1.65	5.5	V
VS	Switch Input / Output Voltage	(Pins 1A, 2A, 1B and 2B)	GND	V _{CC}	V
VI	Digital Control Input Voltage	(Pins 1C and 2C)	GND	5.5	V
T _A	Operating Temperature Range	Operating Temperature Range			°C
t _r , t _f	Input Transition Rise or Fall Time	$V_{CC} = < 3.0 V$	0	20	ns/V
	(ON/OFF Control Input)	$V_{CC} = \ge 3.0 \text{ V}$	0	10	1

Table 3. ELECTRICAL CHARACTERISTICS

					Guaran	teed Limit		
				25	°C	–55° to	125°C	
Symbol	Parameter	Condition	V _{CC}	Min	Max	Min	Max	Unit
V _{IH}	High-Level Input Voltage, Control Input		1.65 to 1.95			V _{CC} x 0.65		V
			2.3 to 5.5			V _{CC} x 0.7		
V _{IL}	Low–Level Input Voltage, Control Input		1.65 to 1.95				V _{CC} x 0.35	V
			2.3 to 5.5				V _{CC} x 0.30	
lj	Input Leakage Current, Control Input	$V_{I} = V_{CC} \text{ or } GND$	5.5		±0.1		±1	μA
I _{S(ON)}	ON-State Switch Leakage Current		5.5		±0.1		±1	μΑ
$I_{S(OFF)}$	OFF-State Switch Leakage Current	$ \begin{array}{l} V_{IS} = V_{CC} \text{ and } V_{OS} = \\ GND, \text{ or } V_{IS} = GND \text{ and} \\ V_{OS} = V_{CC} \text{ GND}, V_{I} = V_{IL}, \end{array} $	5.5		±0.1		±1	μΑ
I _{CC}	Quiescent Supply Current	$V_{I} = V_{CC}$ or GND	5.5		1.0		10	μA
ΔI_{CC}	Supply Current Change	$V_{\rm I} = V_{\rm CC} - 0.6$	5.5				500	μA
CI	Control Input Capacitance		5				3.0	pF
C _{I/O(Off)}	Switch OFF Input / Output Capacitance	See Figure 3	5				6.0	pF
C _{I/O(On)}	Switch ON Input / Output Capacitance	See Figure 4	5				13	pF

Table 4. SWITCHING CHARACTERISTICS

				Guarante	ed Limit	
				–55° to	125°C	
Symbol	Parameter	Condition	V _{cc}	Min	Max	Unit
t _{PLH} , t _{PHL}	Propagation Delay,	C_L = 30 pF, R_L = 1 k Ω	1.8		6.5	ns
	A to B, B to A		2.5		3.3	
		C_L = 50 pF, R_L = 500 Ω	3.3		2.5	
			5.0		2.2	
t _{EN}	Enable Time,	$C_L = 50 \text{ pF}, R_L = 500 \Omega$	1.8		10	ns
(t _{PZL} , t _{PZH})	C to Analog Output (A or B)	See Figure 6	2.5		6.5	
			3.3		5.5	
			5.0		4.9	
t _{DIS}	Disable Time,	$C_L = 50 \text{ pF}, R_L = 500 \Omega$	1.8		9.0	ns
(t _{PLZI} , t _{PHZ})	C to Analog Output (A or B)	See Figure 6	2.5		7.2	
			3.3		6.5	1
			5.0		6.0	1

Table 5. ANALOG SWITCH CHARACTERISTICS

					25°C	–55° to	125°C	
Symbol	Parameter	Conditions		v _{cc}	Тур	Min	Max	Unit
R _{ON}	On-Resistance	$V_{IS} = V_{CC}$ or GND,	I _S = 4 ma	1.65	12		30	Ω
		$V_{I} = V_{IH}$, See Figure 2	I _S = 8 ma	2.3	9		20	
			I _S = 24 ma	3.0	7.5		15	
			I _S = 32 ma	4.5	5.5		13	
R _{ON(peak)}	Peak On-Resistance	$V_{IS} = GND$ to V_{CC} ; $V_I = V_{IH}$,	I _S = 4 ma	1.65	74.5		220	Ω
		See Figure 2	I _S = 8 ma	2.3	20		75	
			I _S = 24 ma	3.0	11.5		25	
			I _S = 32 ma	4.5	7.5		17	
ΔR_{ON}	On–Resistance Mismatch between	$V_{IS} = GND$ to V_{CC} ; $V_I = V_{IH}$,	I _S = 4 ma	1.65			8.0	Ω
	Switches	See Figure 2	I _S = 8 ma	2.3			5.0	
			I _S = 24 ma	3.0			3.0	
			I _S = 32 ma	4.5			2.0	
BW	Bandwidth (f_{-3dB})	$R_L = 50 \Omega, C_L = 5 pF,$		1.65			> 270	MHz
		f _{IN} = Sine Wave See Figure 8		2.3			> 270	
				3.0			> 270	
				4.5			> 270	

				25°C	
Symbol	Parameter	Conditions	V _{cc}	Тур	Unit
ISO _{Off}	Off-Channel	$R_{L} = 600 \Omega, C_{L} = 50 \text{ pF},$	1.65	-70	dB
	Feedthrough Isolation	f _{IN} = 1 MHz Sine Wave See Figure 9	2.3	-70	
			3.0	-70	
			4.5	-70	
		$R_L = 50 \Omega, C_L = 5 pF,$	1.65	-60	
		f _{IN} = 1 MHz Šine Wave See Figure 9	2.3	-60	
			3.0	-60	
			4.5	-60	
XTalk	Crosstalk	$R_{L} = 600 \Omega, C_{L} = 50 \text{ pF},$	1.65	-100	dB
	Between Switches	Between Switches f _{IN} = 1 MHz Sine Wave See Figure 10	2.3	-100	
			3.0	-100	
			4.5	-100	
		$R_L = 50 \Omega, C_L = 5 pF,$	1.65	-90	
		f _{IN} = 1 MHz Sine Wave See Figure 10	2.3	-90	
			3.0	-90	
			4.5	-90	
	Feedthrough Noise,	$R_{L} = 600 \Omega, C_{L} = 50 pF,$	1.65	10	mV _{pp}
	Control to Switch	$f_{IN} = 1 \text{ MHz Square Wave, } t_r = t_f = 2 \text{ ns,}$ See Figure 11	2.3	10	
			3.0	10	
			4.5	15	
THD	Total Harmonic	$C_L = 50 \text{ pF}, R_L = 50 \Omega,$	2.3	0.025	%
	Distortion	f _{IN} = 600 Hz to 20 KHz Sine Wave, See Figure 12	3.0	0.015	
			4.5	0.01	

Table 5. ANALOG SWITCH CHARACTERISTICS (continued)

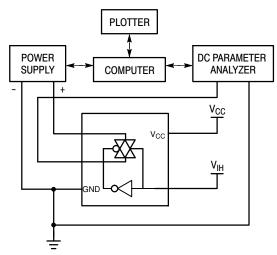
Table 6. POWER DISSIPATION CHARACTERISTICS

				25°C	
Symbol	Parameter	Conditions	V _{CC}	Тур	Unit
C _{PD}	Power Dissipation Capacitance	f = 10 MHz	1.65	8.0	pF
	Capacitance		2.3	8.9	
			3.0	9.6	
			4.5	10.9	

Table 7. DEVICE ORDERING INFORMATION

Device Order Number	Package	Shipping [†]
NLX2G66DMUTAG	UDFN8-0.5P, 1.95 mm x 1.0 mm (Pb-Free)	3000 / Tape & Reel
NLX2G66DMUTCG	UDFN8-0.5P, 1.95 mm x 1.0 mm (Pb-Free)	3000 / Tape & Reel
NLX2G66MU3TCG (In Development)	UDFN8–0.35P, 1.45 mm x 1.0 mm (Pb–Free)	3000 / Tape & Reel
NLX2G66FCTAG	WLCSP8, 1.888 mm x 0.888 mm (Pb-Free)	3000 / Tape & Reel

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.





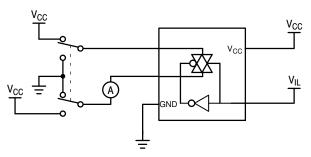


Figure 3. Maximum Off–Channel Leakage Current Test Set–Up

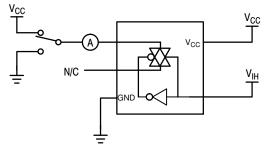
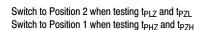
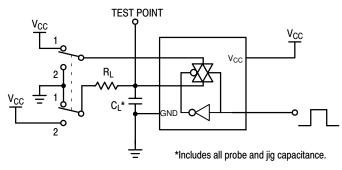


Figure 4. Maximum On–Channel Leakage Current Test Set–Up







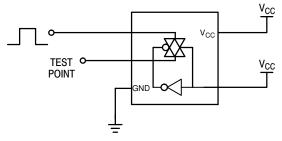
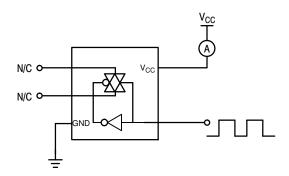
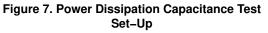
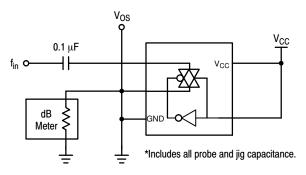
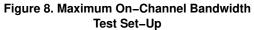


Figure 5. Propagation Delay Test Set-Up









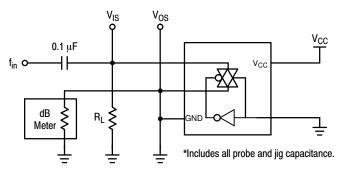


Figure 9. Off–Channel Feedthrough Isolation Test Set–Up

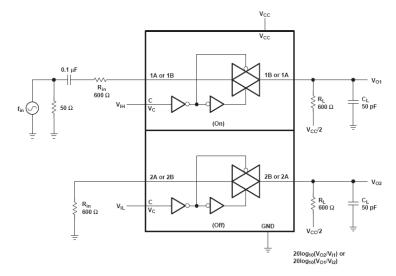
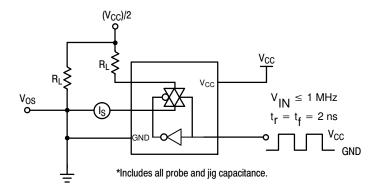
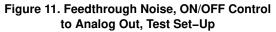


Figure 10. Crosstalk (between Switches)





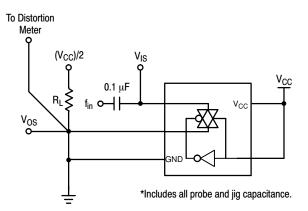


Figure 12. Total Harmonic Distortion Test Set–Up

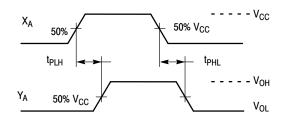


Figure 13. Propagation Delay, Analog In to Analog Out Waveforms

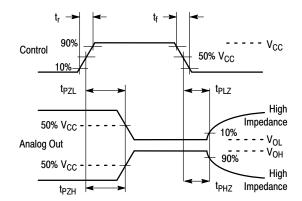
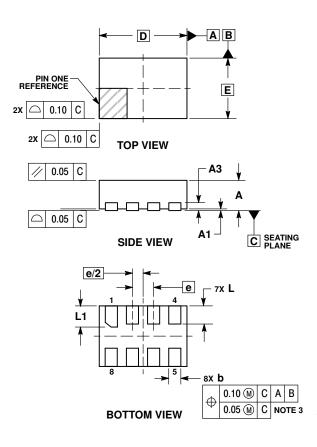


Figure 14. Propagation Delay, ON/OFF Control

PACKAGE DIMENSIONS

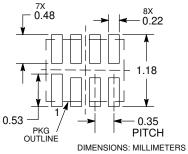
UDFN8 1.45x1.0, 0.35P CASE 517BZ ISSUE O



- NOTES:
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 CONTROLLING DIMENSION: MILLIMETERS.
 DIMENSION & APPLIES TO PLATED TERMINAL AND IS MEASURED BETWEEN 0.15 AND 0.20 MM FROM TERMINAL TIP.
 PACKAGE DIMENSIONS EXCLUSIVE OF BURRS AND MOLD FLASH.

BURRS AND MOLD FL						
		MILLIMETERS				
	DIM	MIN	MAX			
	Α	0.45	0.55			
	A1	0.00	0.05			
	A3	0.13 REF				
	b	0.15	0.25			
	D	1.45 BSC				
	Е	1.00 BSC				
	е	0.35 BSC				
	L	0.25	0.35			
	L1	0.30	0.40			

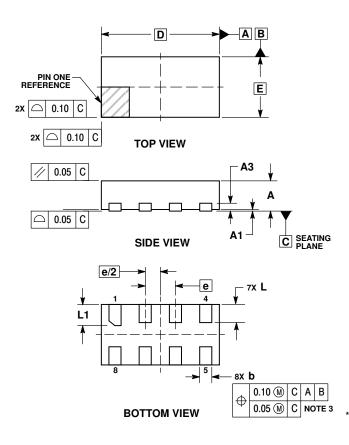
RECOMMENDED SOLDERING FOOTPRINT*



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PACKAGE DIMENSIONS

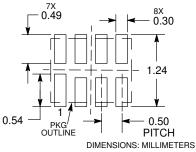
UDFN8 1.95x1.0, 0.5P CASE 517CA ISSUE O



- NOTES: 1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994. 2. CONTROLLING DIMENSION: MILLIMETERS. 3. DIMENSION & APPLIES TO PLATED TERMINAL AND IS MEASURED BETWEEN 0.15 AND 0.20 MM FROM TERMINAL TIP. 4. PACKAGE DIMENSIONS EXCLUSIVE OF BURRS AND MOLD FLASH.

	MILLIMETERS		
DIM	MIN	MAX	
Α	0.45	0.55	
A1	0.00	0.05	
A3	0.13 REF		
b	0.15	0.25	
D	1.95 BSC		
Е	1.00 BSC		
е	0.50 BSC		
L	0.25	0.35	
L1	0.30	0.40	

RECOMMENDED SOLDERING FOOTPRINT*

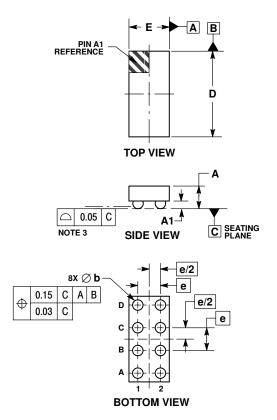


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PACKAGE DIMENSIONS

WLCSP8, 1.888x0.888 CASE 567MR

ISSUE O



2. (3. (DIMEN ASME CONT COPL	Y14.5M, ROLLING	1994. DIMENS	DLERANCING PER SION: MILLIMETER S TO SPHERICAL BALLS.
ſ		MILLIN	IETERS	
	DIM	MIN	MAX	
	Α		0.50	
	A1	0.15	0.19	
	b	0.21	0.25	
	D	1.858	1.918	
	Е	0.858	0.918	
	е	0.50 BSC		

MILLIMETERS

SOLDERING FOOTPRINT* PACKAGE 0.50 PITCH Ø0.20 PITCH

RECOMMENDED

DIMENSIONS: MILLIMETERS

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